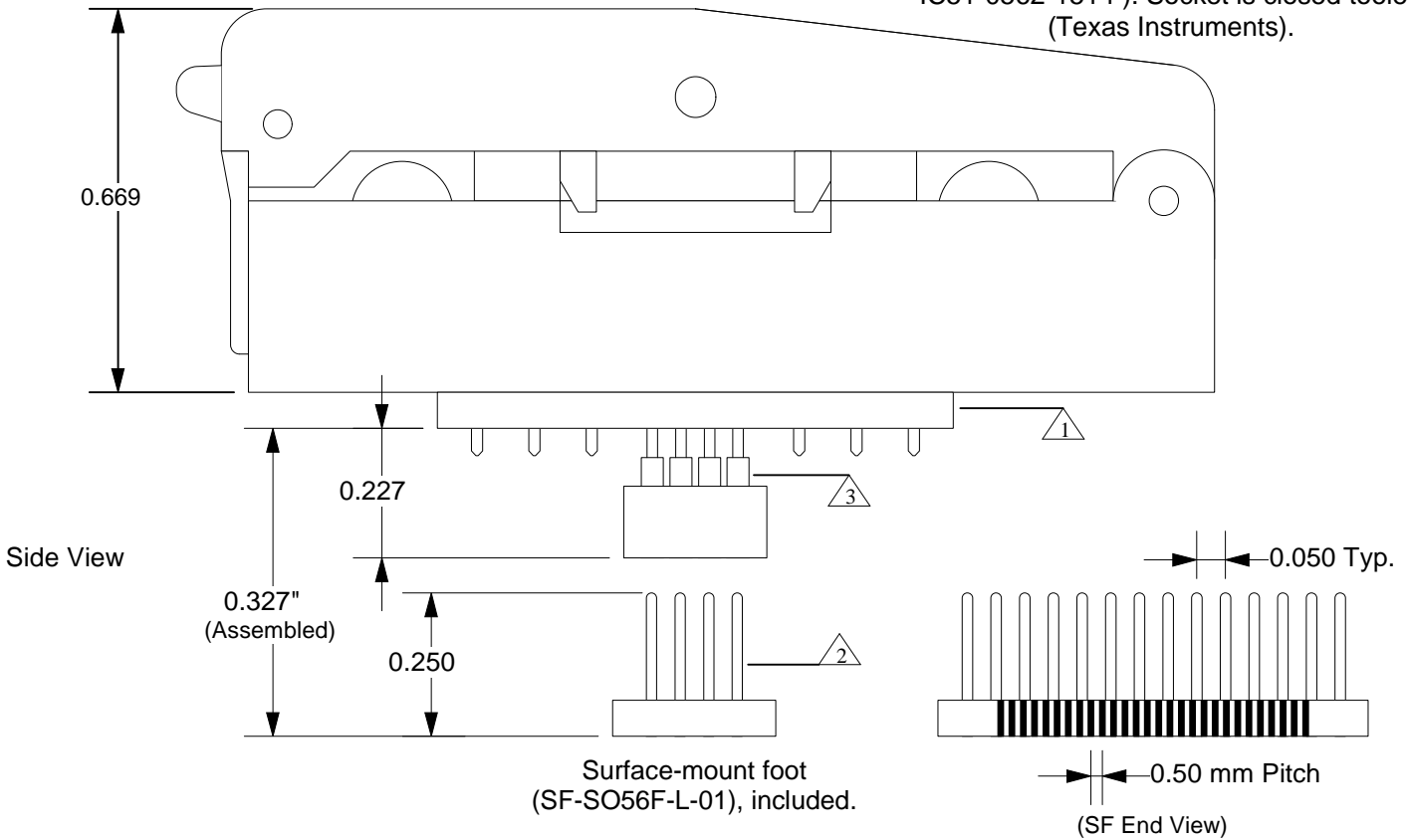


ZIF socket thru-hole interface (Yamaichi IC51-0562-1514). Socket is closed tooled (Texas Instruments).



Surface-mount foot (SF-SO56F-L-01), included.

1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating


2 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).

3 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.)

Description: **CARRIER ADAPTOR**

56 position TSOP (II) ZIF socket with mini grid array pluggable interface to leadless surface mount foot.

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

	CA-SO56F-Z-L-01 Drawing	Status: Released	Scale: 3:1	Rev: A
	© 1998 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100	Drawing by: V. Thao		Date: 3/4/98
		File: CA-SO56F-Z-L-01 Dwg		Modified: